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APPLICATION NO.	FI	LING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.
10/604,835	(08/21/2003	Hung-Wei Liu	11437-US-PA	1834
31561	7590	08/24/2004		EXAMINER	
JIANQ CH 7 FLOOR-1		CELLECTUAL PR	VU, QUANG D		
		SECTION 2		ART UNIT	PAPER NUMBER
,					
TAIWAN				DATE MAILED: 08/24/20	N4

Please find below and/or attached an Office communication concerning this application or proceeding.

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	Application No.	Applicant(s)	
	10/604,835	LIU ET AL.	
Office Action Summary	Examiner	Art Unit	
	Quang D Vu	2811	
The MAILING DATE of this communication Period for Reply	appears on the cover sheet w	vith the correspondence addres	'S
A SHORTENED STATUTORY PERIOD FOR RE THE MAILING DATE OF THIS COMMUNICATIO - Extensions of time may be available under the provisions of 37 CFF after SIX (6) MONTHS from the mailing date of this communication - If the period for reply specified above is less than thirty (30) days, a - If NO period for reply is specified above, the maximum statutory pe - Failure to reply within the set or extended period for reply will, by st Any reply received by the Office later than three months after the m earned patent term adjustment. See 37 CFR 1.704(b).	N. R 1.136(a). In no event, however, may a reply within the statutory minimum of th riod will apply and will expire SIX (6) MC atute, cause the application to become A	n reply be timely filed irty (30) days will be considered timely. NNTHS from the mailing date of this commun NBANDONED (35 U.S.C. § 133).	nication.
Status			
 1) Responsive to communication(s) filed on 0 2a) This action is FINAL. 2b) 3 3) Since this application is in condition for allo closed in accordance with the practice und 	This action is non-final. wance except for formal ma		rits is
Disposition of Claims			
4) ⊠ Claim(s) 1-10 is/are pending in the applicate 4a) Of the above claim(s) is/are with 5) □ Claim(s) is/are allowed. 6) ⊠ Claim(s) 1-10 is/are rejected. 7) □ Claim(s) is/are objected to. 8) □ Claim(s) are subject to restriction are	drawn from consideration.		
Application Papers			
9) The specification is objected to by the Exan 10) The drawing(s) filed on is/are: a) Applicant may not request that any objection to Replacement drawing sheet(s) including the con 11) The oath or declaration is objected to by the	accepted or b) objected to the drawing(s) be held in abeya rrection is required if the drawin	ance. See 37 CFR 1.85(a). ng(s) is objected to. See 37 CFR 1.	
Priority under 35 U.S.C. § 119			
12) Acknowledgment is made of a claim for fore a) All b) Some * c) None of: 1. Certified copies of the priority docum 2. Certified copies of the priority docum 3. Copies of the certified copies of the application from the International Bu * See the attached detailed Office action for a	nents have been received. nents have been received in priority documents have bee reau (PCT Rule 17.2(a)).	Application No n received in this National Sta	ge
Attachment(s) 1) Notice of References Cited (PTO-892)	· —	y Summary (PTO-413)	
 Notice of Draftsperson's Patent Drawing Review (PTO-948 Information Disclosure Statement(s) (PTO-1449 or PTO/SE Paper No(s)/Mail Date 	′	o(s)/Mail Date f Informal Patent Application (PTO-152 	?)

Application/Control Number: 10/604,835

Art Unit: 2811

DETAILED ACTION

Election/Restrictions

Applicant's election without traverse of group I (claims 1-10) in the reply filed on 07/02/04 is acknowledged.

Claim Rejections - 35 USC § 102

1. The following is a quotation of the appropriate paragraphs of 35 U.S.C. 102 that form the basis for the rejections under this section made in this Office action:

A person shall be entitled to a patent unless -

- (b) the invention was patented or described in a printed publication in this or a foreign country or in public use or on sale in this country, more than one year prior to the date of application for patent in the United States.
- 2. Claims 1-10 are rejected under 35 U.S.C. 102(b) as being anticipated by US Patent No. 6,242,785 to Hossain et al.

Regarding claim 1, Hossain et al. (figures 1-13) teach a method for forming a metal silicide layer, comprising:

providing a silicon layer (silicon gate [14]);

introducing ions (32) in the silicon layer (14) to form a barrier layer (34) in the silicon layer,

forming a metal layer (40) on the silicon layer (14);

performing an annealing process so that the silicon layer reacts with the metal layer to form the metal silicide layer (44) (column 9, lines 20-36); and removing the unreacted metal layer.

Application/Control Number: 10/604,835

Art Unit: 2811

Regarding claim 2, Hossain et al. teach the ions comprises nitrogen ions (column 8, lines 52-53).

Regarding claim 3, Hossain et al. teach the inert ions includes argon ions (column 8, lines 52-53).

Regarding claim 4, Hossain et al. teach a material of the metal is selected from tungsten (column 9, lines 22-25).

Regarding claim 5, Hossain et al. teach the step of introducing ions in the silicon layer, which is performed by an ion implantation process (column 8, lines 35-55).

Regarding claim 6, Hossain et al. teach (figures 1-13) teach a method of forming semiconductor device, comprising:

forming a gate structure (14) on a substrate (10), wherein the gate structure comprised a silicon layer (column 6, lines 54-55);

forming a source/drain region (30) beside the gate structure;

forming a spacer (22) on the side wall on the gate structure;

introducing ions (32) into the silicon layer (14) and the source/drain (30) to form a barrier layer (34) in the silicon layer (14) and the source/drain (30);

forming a metal layer (40) on the substrate (10);

performing an annealing process so that the silicon layer and the source/drain react with the metal to form a metal silicide layer (44) (column 9, lines 20-36); and

removing the unreacted metal layer.

Regarding claim 7, Hossain et al. teach the ions comprises nitrogen ions (column 8, lines 52-53).

Regarding claim 8, Hossain et al. teach the inert ions includes argon ions (column 8, lines 52-53).

Regarding claim 9, Hossain et al. teach a material of the metal is selected from tungsten (column 9, lines 22-25).

Regarding claim 10, Hossain et al. teach the step of introducing ions in the silicon layer, which is performed by an ion implantation process (column 8, lines 35-55).

Conclusion

Any inquiry concerning this communication or earlier communications from the examiner should be directed to Quang D Vu whose telephone number is 571-272-1667. The examiner can normally be reached on Monday-Friday.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Eddie Lee can be reached on 571-272-1732. The fax phone number for the organization where this application or proceeding is assigned is 703-872-9306.

Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see http://pair-direct.uspto.gov. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free).

Application/Control Number: 10/604,835

Art Unit: 2811

qv

August 20, 2004

Kanzbonshie DONGHEE KANG

Page 5

PRIMARY EXAMINER